

PFC/PWM C Ile C mbi a i

FAN4800AS/CS/01S/2S

Description

The highly integrated FAN4800AS/CS/01S/02S parts are specially designed for power supplies that consist of boost PFC and PWM. They require very few external components to achieve versatile by at Light Load

- $f_{RTCT} = 4 \cdot f_{PFC} = 4 \cdot f_{PWM}$ for FAN4800AS/01S
- $f_{RTCT} = 4 \cdot f_{PFC} = 2 \cdot f_{PWM}$ for FAN4800CS/02S
- These are Pb Free Devicesµ

Internet Server Power Supply

• LCD TV, Monitor Power Supply

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Application Diagram

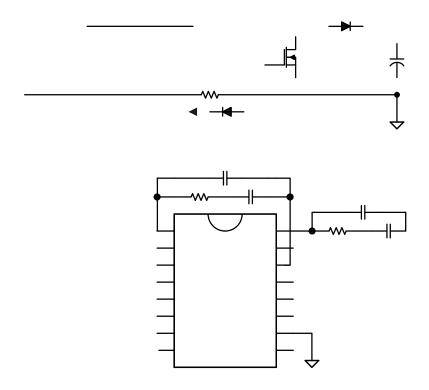


Figure 1. Typical Application, Current Mode

Application Diagram



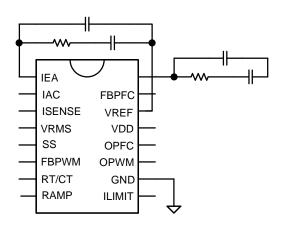


Figure 2. Typical Application, Voltage Mode

| Pin Configuration | |
|-------------------|--|
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Table 2. ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | | | Max | Unit |
|----------------------|---|-----------------------------------|------|--------------|------|
| V _{DD} | DC Supply Voltage | | - | 30 | V |
| V _H | SS, FBPWM, RAMP, OPWM, OPFC, VREF | SS, FBPWM, RAMP, OPWM, OPFC, VREF | | 30.0 | V |
| V_{L} | IAC, VRMS, RT/CT, ILIMIT, FBPFC, VEA | | -0.3 | 7.0 | V |
| V_{IEA} | IEA | | 0 | VREF +0.3 | V |
| V _N | ISENSE | | | 0.7 | V |
| I _{AC} | Input AC Current | | - | 1 | mA |
| I _{REF} | V _{REF} Output Current | | - | 5 | mA |
| I _{PFC-OUT} | Peak PFC OUT Current, Source or Sink | | - | 0.5 | Α |
| I _{PWM-OUT} | Peak PWM OUT Current, Source or Sink | | - | 0.5 | Α |
| P _D | Power Dissipation T _A < 50°C | | - | 800 | mW |
| θ_{JA} | Thermal Resistance (Junction-to-Air) DIP | | - | 80.80 | °C/W |
| | | SOP | - | 104.10 | |
| $\theta_{\sf JC}$ | Thermal Resistance (Junction-to-Case) | DIP | - | 35.38 | °C/W |
| | SOP | | • | • | |

Table 4. ELECTRICAL CHARACTERISTICS

(Unless otherwise noted, V $_{DD}$ = 15 V, T $_{A}$ = 25 °C, T $_{A}$ = T $_{J},~R_{T}$ = 6.8 k $\Omega,$ and C $_{T}$ = 1000 pF)

| Symbol | Parameter | Test Condition | Min | Тур | Max | Unit |
|-------------------------|--------------------------------|---|-----|-----|-----|------|
| V _{DD} SECTION | | | | | | |
| V _{DD-OP} | Continuously Operating Voltage | | - | - | 26 | V |
| I _{DD-ST} | Startup Current | V _{DD} = V _{TH-ON} - 0.1 V, OPFC OPWM Open | - | 30 | 80 | μΑ |
| I _{DD-OP} | Operating Current | V _{DD} = 13 V, OPFC OPWM Open | 2.0 | 2.6 | 5.0 | mA |
| V _{TH-ON} | Turn-On Threshold Voltage | | 10 | 11 | 12 | V |
| ΔV_{TH} | Hysteresis | | 1.3 | - | 1.9 | V |
| V _{DD-OVP} | V _{DD} OVP | | 27 | - | - | - |

Table 4. ELECTRICAL CHARACTERISTICS (continued)

(Unless otherwise noted, V_{DD} = 15 V, T_A = 25°C, T_A = T_J , R_T = 6.8 k Ω , and C_T = 1000 pF)

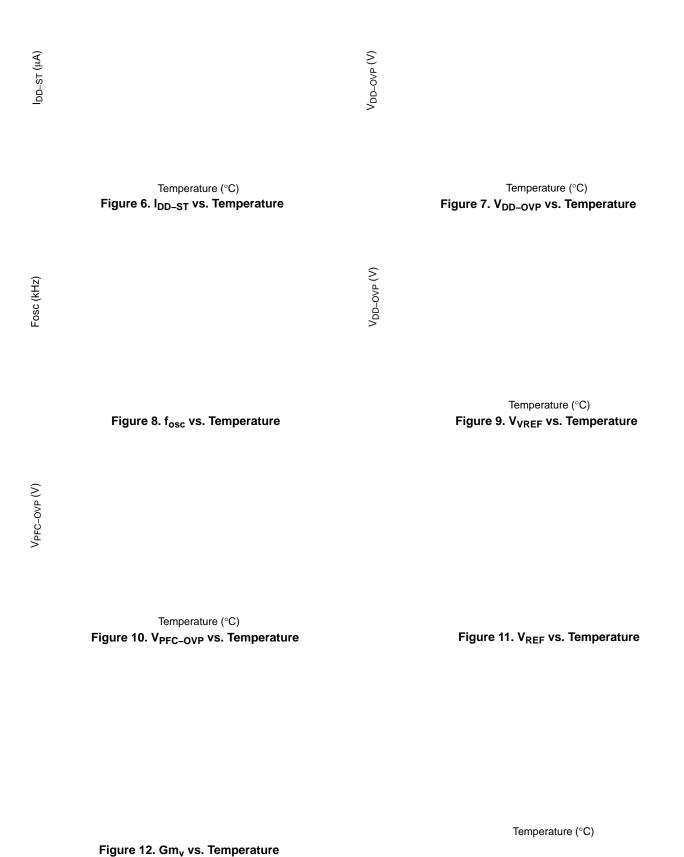
| Symbol | Parameter | Test Condition | Min | Тур | Max | Unit |
|----------------------------|---|--|-------|-------|--------|------|
| OLTAGE ERRO | R AMPLIFIER | | | | | |
| V _{REF} | Reference Voltage | | 2.45 | 2.50 | 2.55 | V |
| A _V | Open-Loop Gain (Note 3) | | 35 | 42 | _ | dB |
| Gm _v | Transconductance | $V_{NONINV} = V_{INV}, V_{VEA} = 3.75 V$ | 50 | 70 | 90 | umho |
| I _{FBPFC-L} | Maximum Source Current | V _{FBPFC} = 2 V, V _{VEA} = 1.5 V | 40 | 50 | - | μΑ |
| I _{FBPFC-H} | Maximum Sink Current | V _{FBPFC} = 3 V, V _{VEA} = 6 V | - | -50 | -40 | μΑ |
| I _{BS} | Input Bias Current | | -1 | - | 1 | μΑ |
| V _{VEA-H} | Output High Voltage on V _{VEA} | | 5.8 | 6.0 | - | V |
| V_{VEA-L} | Output Low Voltage on V _{VEA} | | - | 0.1 | 0.4 | V |
| URRENT ERRO | DR AMPLIFIER | | | | • | • |
| Gm _I | Transconductance | $V_{NONINV} = V_{INV}, V_{IEA} = 3.75 V$ | 78 | 88 | 100 | umho |
| V _{OFFSET} | Input Offset Voltage | V _{VEA} = 0 V, IAC Open | -10 | - | 10 | mV |
| V _{IEA-H} | Output High Voltage | | 6.8 | 7.4 | 8.0 | V |
| V _{IEA-L} | Output Low Voltage | | _ | 0.1 | 0.4 | V |
| ΙL | Source Current | $V_{ISENSE} = -0.6 \text{ V}, V_{IEA} = 1.5 \text{ V}$ | 35 | 50 | - | μΑ |
| I _H | Sink Current | V _{ISENSE} = +0.6 V, V _{IEA} = 4.0 V | _ | -50 | -35 | μΑ |
| A _I (Note 3) | Open–Loop Gain | | 40 | 50 | _ | dB |
| iFault Detect™ | | | | ı | ı | |
| t _{FBPFC_OPEN} | Time to FBPFC Open | V _{FBPFC} = V _{PFC-UVP} to FBPFC OPEN, 470 pF from FBPFC to GND | - | 2 | 4 | ms |
| V _{PFC-UVP} | PFC Feedback Under–Voltage Protection | | 0.4 | 0.5 | 0.6 | V |
| AIN MODULAT | OR | | | | • | • |
| I _{AC} | Input for AC Current (Note 3) | Multiplier Linear Range | 0 | _ | 100 | μΑ |
| GAIN | GAIN Modulator (Note 4) | I_{AC} = 17.67 μ A, V_{RMS} = 1.080 V V_{FBPFC} = 2.25 V | 7.500 | 9.000 | 10.500 | |
| | | I_{AC} = 20.00 μ A, V_{RMS} = 1.224 V V_{FBPFC} = 2.25 V | 6.367 | 7.004 | 7.704 | |
| | | I_{AC} = 25.69 μ A, V_{RMS} = 1.585 V V_{FBPFC} = 2.25 V | 3.801 | 4.182 | 4.600 | |
| | | $I_{AC} = 51.62 \mu A, V_{RMS} = 3.169 V$ $V_{FBPFC} = 2.25 V$ | 0.950 | 1.045 | 1.149 | |
| | | $I_{AC} = 62.23 \mu A, V_{RMS} = 3.803 V$ $V_{FBPFC} = 2.25 V$ | 0.660 | 0.726 | 0.798 | |
| BW | Bandwidth (Note 3) | I _{AC} = 40 μA | - | 2 | - | kHz |
| V _o (gm) | Output Voltage = 5.7 k Ω x (I _{SENSE} – I _{OFFSET}) | $I_{AC} = 20 \mu A$, $V_{RMS} = 1.224 V$ $V_{FBPFC} = 2.25 V$ | 0.710 | 0.798 | 0.885 | V |
| FC I _{LIMIT} COMF | PARATOR | | | | | |
| V _{PFC-ILIMIT} | Peak Current Limit Threshold Voltage, Cycle-by-Cycle Limit | | -1.35 | -1.20 | -1.05 | V |
| ΔV_{PK} | PFC I _{LIMIT} -Gain Modulator Output | I _{AC} = 17.67 μA, V _{RMS} = 1.08 V V _{FBPFC} = 2.25 V | 200 | - | - | mV |
| | • | | | | • | |

Table 4. ELECTRICAL CHARACTERISTICS (continued)

(Unless otherwise noted, V_{DD} = 15 V, T_A = 25°C, T_A = T_J , R_T = 6.8 k Ω , and C_T = 1000 pF)

| Symbol | Parameter | Test Condition | Min | Тур | Max | Unit |
|-------------------------|------------------------------|---|-----|-----|-----|------|
| PFC OUTPUT DR | RIVER | | | | | |
| V _{GATE-CLAMP} | Gate Output Clamping Voltage | V _{DD} = 22 V | 13 | 15 | 17 | V |
| V_{GATE-L} | Gate Low Voltage | $V_{DD} = 15 \text{ V}, I_{O} = 100 \text{ mA}$ | - | - | 1.5 | V |
| V_{GATE-H} | Gate High Voltage | $V_{DD} = 13 \text{ V}, I_{O} = 100 \text{ mA}$ | 8 | - | - | V |
| t _R | Gate Rising Time | $V_{DD} = 15 \text{ V}, C_L = 4.7 \text{ nF},$ | | | | |
| | | | | | | |

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)

V_{SS} (μA)

-40 -25 -Temperature (°C) Figure 22. I_{SS} vs. Temperature

Temperature (°C) Figure 23. I_{TC} vs. Temperature

Functional Description

The FAN4800AS/CS/01S/02S consist of an average current controlled, continuous boost, Power Factor Correction (PFC) front end and a synchronized Pulse Width Modulator (PWM) back end. The PWM can be used in current or voltage mode. In voltage mode, feedforward from the PFC output bus can help improve the line regulation of PWM. In either mode, the PWM stage uses conventional trailing edge, duty cycle modulation. This proprietary leading / trailing edge modulation results in a higher usable PFC error amplifier bandwidth and can significantly reduce the size of the PFC DC bus capacitor.

The synchronization of the PWM with the PFC simplifies the PWM compensation due to the controlled ripple on the PFC output capacitor (the PWM input capacitor).

In addition to power factor correction, a number of protection features are built into this series. They include soft

low, too high, or open; TriFault Detect senses the error and terminates the PFC output drive.

TriFault Detect is an entirely internal circuit. It requires no external components to serve its protective function.

PFC Over-Voltage Protection

In the FAN4800AS/CS/01S/02S, the PFC OVP comparator serves to protect the power circuit from being subjected to excessive voltages if the load changes suddenly. A resistor divider from the high voltage DC output of the PFC is fed to FBPFC. When the voltage on FBPFC exceeds 2.75 V, the PFC output driver is shut down. The PWM section continues to operate. The OVP comparator has 250 mV of hysteresis and the PFC does not restart until the voltage at FBPFC drops below 2.5 V. V_{DD} OVP can also serve as a redundant PFC OVP protection. V_{DD} OVP threshold is 28 V with 1 V hysteresis.

Selecting PFC R_{sense}

 R_{sense} is the sensing resistor of the PFC boost converter. During the steady state, line input current x R_{sense} equals $I_{GAINMOD} \ x \ 5.7 \ k\Omega$

At full load, the average V_{VEA} needs to around 4.5 V and ripple on the VEA pin needs to be less than 400 mV. Choose the resistance of the sensing resistor:

$$\mathsf{R}_{\mathsf{SENSE}} = \frac{(4.5-0.7)\times5.7\,\mathsf{k}\Omega\times\mathsf{IAC}\times\mathsf{Gain}\times\mathsf{V}_{\mathsf{IN}}\times\sqrt{2}}{2\times(5.6-0.7)\times\mathsf{Line_Input_Power}}$$
 (eq. 2)

where 5.6 is V

The programmable range of second level PFC output voltage is 340 V $\sim 300 \ V.$

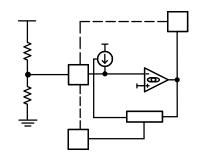


Figure 25. Two-Level PFC Scheme

is then compared with the modulating ramp up. The effective duty cycle of the trailing edge modulation is determined during the on time of the switch.

In the case of leading edge modulation, the switch is turned off exactly at the leading edge of the system clock.

When the modulating ramp reaches the level of the error amplifier output voltage, the switch is turned on. The effective duty cycle of the leading edge modulation is determined during off time of the switch.

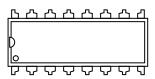
Table 5. ORDERING INFORMATION

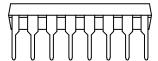
| Part Number | Operating Temperature Range | Package | Packing Method |
|-------------|-----------------------------|------------------------------------|----------------|
| FAN4800ASNY | −40°C to 105°C | 16-Pin Dual Inline Package (DIP) | Tube |
| FAN4800CSNY | -40°C to 105°C | 16-Pin Dual Inline Package (DIP) | Tube |
| FAN4800CSMY | -40°C to 105°C | 16-Pin Small Outline Package (SOP) | Tape & Reel |
| FAN4801SNY | -40°C to 105°C | 16-Pin Dual Inline Package (DIP) | Tube |
| FAN4801SMY | -40°C to 105°C | 16-Pin Small Outline Package (SOP) | Tape & Reel |
| FAN4802SNY | -40°C to 105°C | 16-Pin Dual Inline Package (DIP) | Tube |
| FAN4802SMY | −40°C to 105°C | 16-Pin Small Outline Package (SOP) | Tape & Reel |



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STYLE 1:

GENERIC MARKING DIAGRAM*

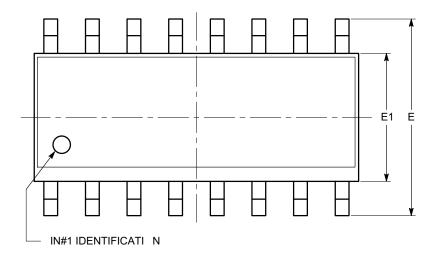


XXXXX = Specific Device Code A = Assembly Location

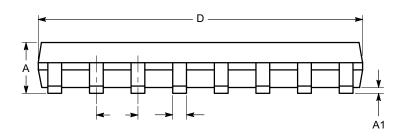
WL = Wafer Lot
 YY = Year
 WW = Work Week
 G = Pb-Free Package

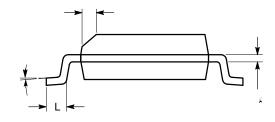
^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " •", may or may not be present.

DATE 19 DEC 2008



TOP VIEW





END VIEW SIDE VIEW

Notes:

- (1) A ... n n .. na , ... n m... m , . An ... n , ... (2) C m JEDEC MS-012.

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